

ESDLIN03-1BWY

Automotive single-line Transil™, transient voltage suppressor (TVS) for LIN bus

Datasheet - production data

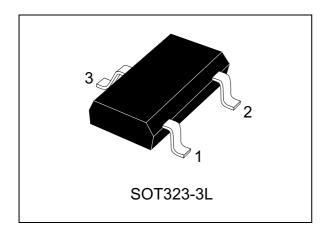
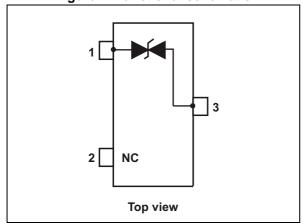


Figure 1. Functional schematic



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Complies with the following standards

- ISO 10605 C = 150 pF, R = 330 Ω :
 - ±30 kV (air discharge)
 - ±30 kV (contact discharge)
- ISO 10605 C = 330 pF, R = 330 Ω :
 - ±30 kV (air discharge)
 - ±30 kV (contact discharge)
- ISO 7637-3:
 - Pulse 3a: $V_s = -150 \text{ V}$
 - Pulse 3b: $V_s = +100 \text{ V}$

Application

LIN bus lines where electrostatic discharge and other transients must be suppressed. This product is compliant with most of automotive interfaces.

Description

The ESDLIN03-1BWY is a single-line Transil specifically designed for the protection of the automotive LIN bus lines against electrostatic discharge (ESD) and transient voltages.

Features

Single-line ESD and EOS protection

Stand-off voltage: 26.5 V

· Bidirectional device

Max pulse power: 250 W (8/20 μs)

Low clamping factor V_{CL} / V_{BR}

Low leakage current

ECOPACK[®]2 compliant component

AEC-Q101 qualified

TM: Transil is a trademark of STMicroelectronics

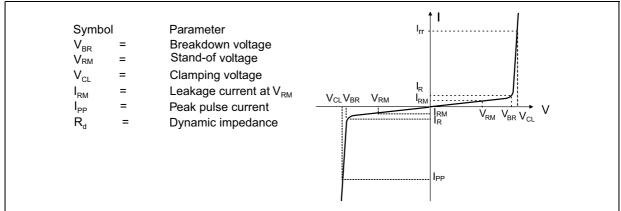
Characteristics ESDLIN03-1BWY

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25$ °C)

Symbol		Value	Unit		
V _{PP}		ISO 10605 - C = 150 pF, F Contact discharge Air discharge	30 30		
	Electrostatic discharge capability	ISO 10605 - C = 330 pF, F Contact discharge Air discharge	30 30	kV	
		HBM MIL STD 883	30		
P _{PP}	Peak pulse power dissipation (8/20 μ s) T_j initial = T_{amb}			250	W
I _{PP}	Peak pulse current (8/20 μs)			3.7	Α
T _j	Operating junction temperature range			-55 to +175	°C
T _{stg}	Storage temperature range			-55 to +175	°C

Figure 2. Electrical characteristics (definitions)

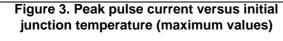


ESDLIN03-1BWY Characteristics

Table 2. Electrical characteristics (values, T_{amb} = 25 °C)

Symbol	Test conditions			Тур.	Max.	Unit
V_{RM}	ESDLIN03-1BWY				26.5	V
V _{BR}	I _R = 1 mA		28.5			V
	V _{RM} = 24 V	T _i = 25 °C			10	nA
1	V _{RM} = 5V	1 1 23 0			1	
I _{RM}	V _{RM} = 24 V	T _i = 125 °C			50	
	V _{RM} = 5V	1 _j = 125 C			10	
	ISO 7637-3 Pulse 3a (U _s = -150 V)					
V	ISO 7637-3 Pulse 3b (U _s = +100 V)				39	V
V _{CL}	IEC 61000-4-5 (8/20 μs), I _{PP} = 1 A				37	
	IEC 61000-4-5 (8/20 μs), I _{PP} = 3A				44	
С	V _R = 0 V DC, f = 1 MHz			3	3.5	pF
αT ⁽¹⁾	Voltage temperature coefficient				9	10 ⁻⁴ /°C

^{1.} V_{BR} at $T_j = V_{BR}$ at 25°C x (1 + α T x ($T_j - 25$))



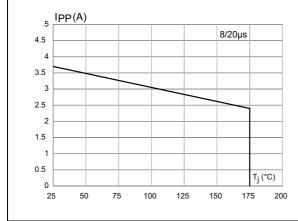
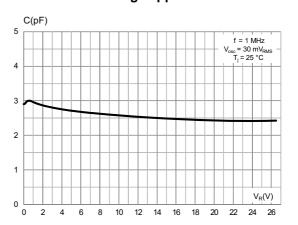


Figure 4. Junction capacitance versus reverse voltage applied



Characteristics ESDLIN03-1BWY

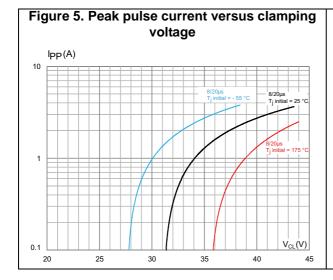
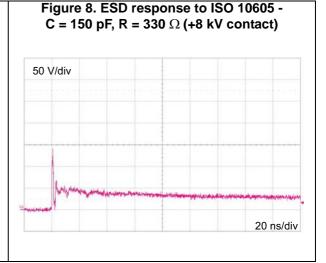
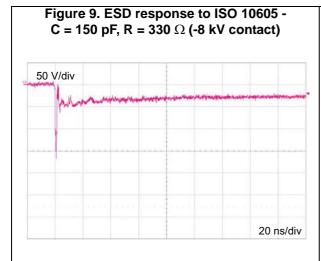
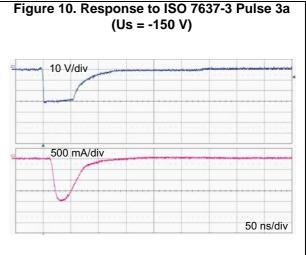


Figure 6. Leakage current versus junction temperature

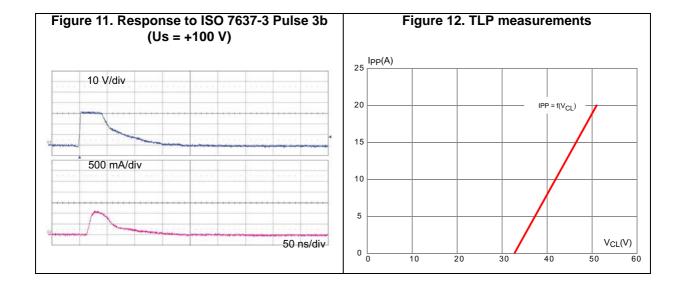
Figure 7. S21 attenuation measurement S21(dB) Sdd21 0 -5 -10 -15 -20 -25 -30 -35 f(Hz) -40 3G 30M 100M 300M 1Ġ







ESDLIN03-1BWY Characteristics



Package information ESDLIN03-1BWY

2 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

2.1 SOT323-3L package information

Figure 13. SOT323-3L package outline Ε D

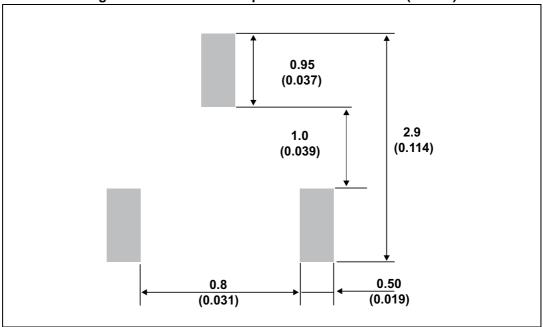
ESDLIN03-1BWY Package information

Table 3. SOT323-3L package mechanical data

	Dimensions						
Ref.	Millimeters			Inches ⁽¹⁾			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	0.8		1.1	0.031		0.043	
A1	0.0		0.1	0.0		0.004	
b	0.25		0.4	0.01		0.016	
С	0.1		0.26	0.004		0.01	
D	1.8	2.0	2.2	0.071	0.079	0.086	
Е	1.15	1.25	1.35	0.045	0.049	0.053	
е		0.65			0.026		
Н	1.8	2.1	2.4	0.071	0.083	0.094	
L	0.1	0.2	0.3	0.004	0.008	0.012	
θ	0		30°	0		30°	

^{1.} Values in inches are converted from mm and rounded to 4 decimal digits.

Figure 14. SOT323-3L footprint dimensions in mm (inches)



Package information ESDLIN03-1BWY

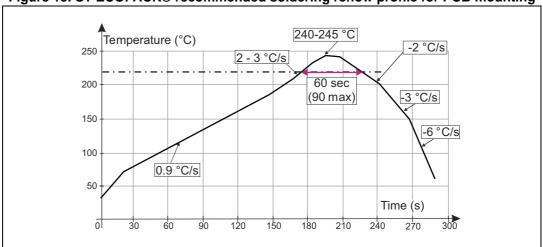
2.2 PCB design preference

 To control the solder paste amount, the closed via is recommended instead of open vias.

2. The position of tracks and open vias in the solder area should be well balanced. The symmetrical layout is recommended, in case any tilt phenomena caused by asymmetrical solder paste amount due to the solder flow away.

2.3 Reflow profile

Figure 15. ST ECOPACK® recommended soldering reflow profile for PCB mounting



Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

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3 Ordering information

Figure 16. Ordering information scheme

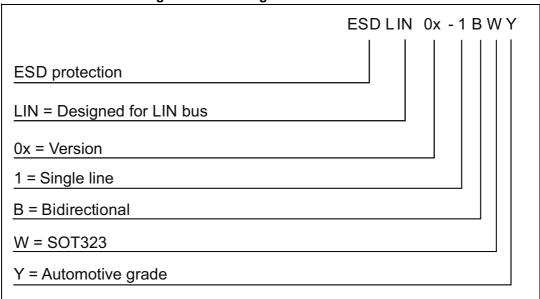


Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
ESDLIN03-1BWY	C12	SOT-323-3L	6.58 mg	3000	Tape and reel

4 Revision history

Table 5. Document revision history

Date	Revision	Changes
05-Jan-2016	1	Initial release.

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